


# **EXHIBIT 15**

**U.S. Patent No. 6,871,264**

Claim 1	Identification: Lenovo moto Edge 5G <sup>1</sup>
1. A processor integrated circuit capable of executing more than one instruction stream comprising:	<div data-bbox="520 412 1024 467"> <b>Motorola edge 5G UW</b> </div> <div data-bbox="520 474 644 500"> Nebula Blue </div> <div data-bbox="520 511 814 548"> ★★★★☆ <a href="#">738 Reviews</a> </div> <div data-bbox="682 613 1192 1268">  </div> <div data-bbox="1241 332 1463 370"> <b>Performance</b> </div> <div data-bbox="1241 418 1386 474"> Bluetooth Bluetooth® 5.2 </div> <div data-bbox="1241 570 1365 596"> <b>Processor</b> </div> <div data-bbox="1241 599 1883 626"> Qualcomm® Snapdragon™ 778G mobile platform   Adreno™ 642L GPU </div> <div data-bbox="1241 719 1339 747"> <b>Storage</b> </div> <div data-bbox="1241 751 1577 777"> 6GB RAM   128GB or 256GB Storage </div> <div data-bbox="1241 870 1444 898"> <b>Operating System</b> </div> <div data-bbox="1241 902 1362 927"> Android™ 11 </div> <div data-bbox="1241 1021 1341 1049"> <b>Hotspot</b> </div> <div data-bbox="1241 1052 1371 1078"> Wi-fi hotspot </div> <div data-bbox="1241 1172 1344 1200"> <b>Security</b> </div> <div data-bbox="1241 1203 1883 1229"> Side-mounted fingerprint reader   Face unlock   ThinkShield for mobile </div>

<sup>1</sup> Additional infringing products include devices featuring ARM DynamIQ, sold or offered for sale by Verizon, including but not limited to, Motorola Edge+, Moto Edge 20, Google Pixel 6 Pro, and Google Pixel 6, Google Pixel 5, and Google Pixel 4 devices.

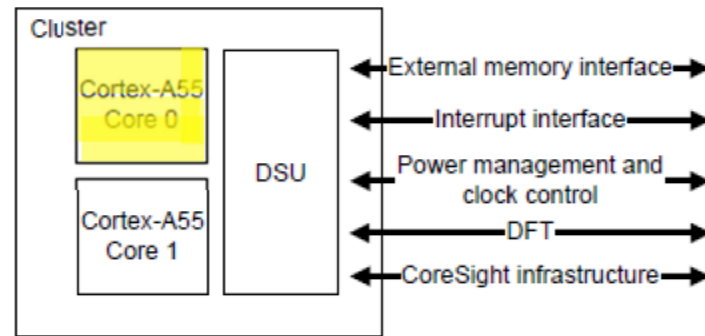
	<p><a href="https://www.verizon.com/smartphones/motorola-edge-5g-uw/">https://www.verizon.com/smartphones/motorola-edge-5g-uw/</a></p> <p>Moto edge 5G includes a Qualcomm Snapdragon 778G mobile platform processor, which uses the Qualcomm Kryo 670 CPU.</p> <p><a href="#">Snapdragon 778G 5G Mobile Platform   Qualcomm</a></p> <p><b>Kryo 670</b> <a href="#">[edit]</a></p> <p>The Kryo 670 CPU was announced with the Snapdragon 780G on 25 March 2021.<sup>[39]</sup> It is also used in the Snapdragon 778G and 778G+, as well as the 782G.</p> <ul style="list-style-type: none"><li>• 1 Kryo 670 Prime (ARM Cortex-A78 based) @ 2.4-2.7 GHz</li><li>• 3 Kryo 670 Gold (ARM Cortex-A78 based) @ 2.2 GHz</li><li>• 4 Kryo 670 Silver (ARM Cortex-A55 based) @ 1.9 GHz</li><li>• 778G/778G+/782G: TSMC 6 nm (N6) Process</li><li>• 780G: Samsung 5 nm LPE Process</li></ul> <p><a href="https://en.wikipedia.org/wiki/Kryo">https://en.wikipedia.org/wiki/Kryo</a></p>
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a first processor, coupled to fetch instructions and access data through a first cache controller;

The Cortex-A55 core is a mid-range, low-power core that implements the ARMv8-A architecture with support for the v8.2 extension, the RAS extension, the Load acquire (LDAPR) instructions introduced in the ARMv8.3 extension, and the Dot Product instructions introduced in the ARMv8.4 extension.

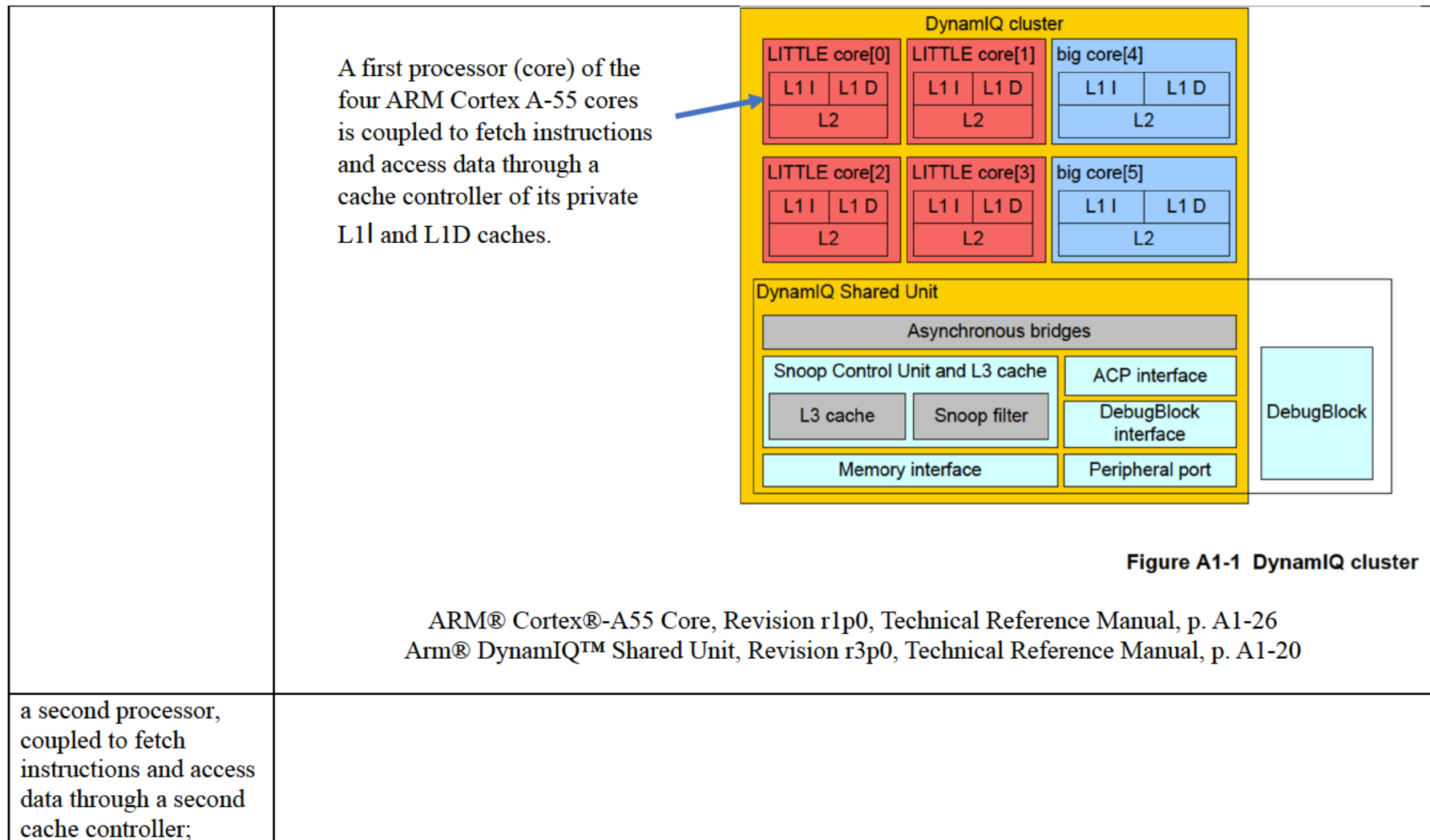
The core has a *Level 1* (L1) memory system, and private *Level 2* (L2) cache. The core is implemented inside the DynamIQ Shared Unit (DSU) as a Little core and is highly configurable with other cores.

The following figure shows an example of a dual-core configuration.



**Figure A1-1 Example dual-core configuration with homogeneous cores**

ARM® Cortex®-A55 Core, Revision r1p0, Technical Reference Manual



A second processor (core) of the four ARM Cortex A-55 cores is coupled to fetch instructions and access data through a cache controller of its private L1I and L1D caches.

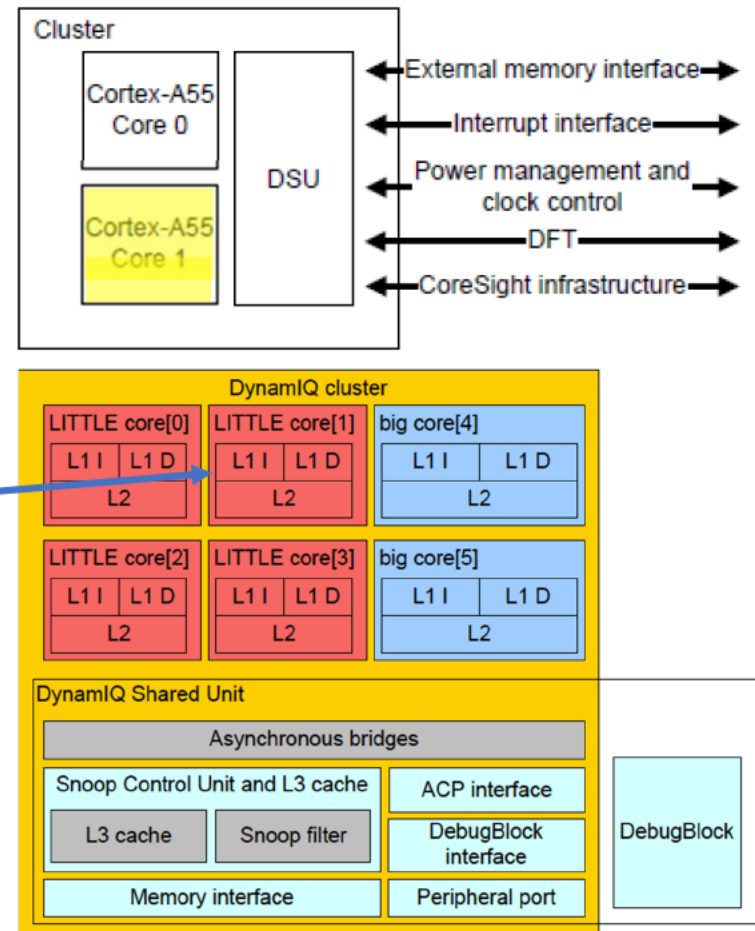
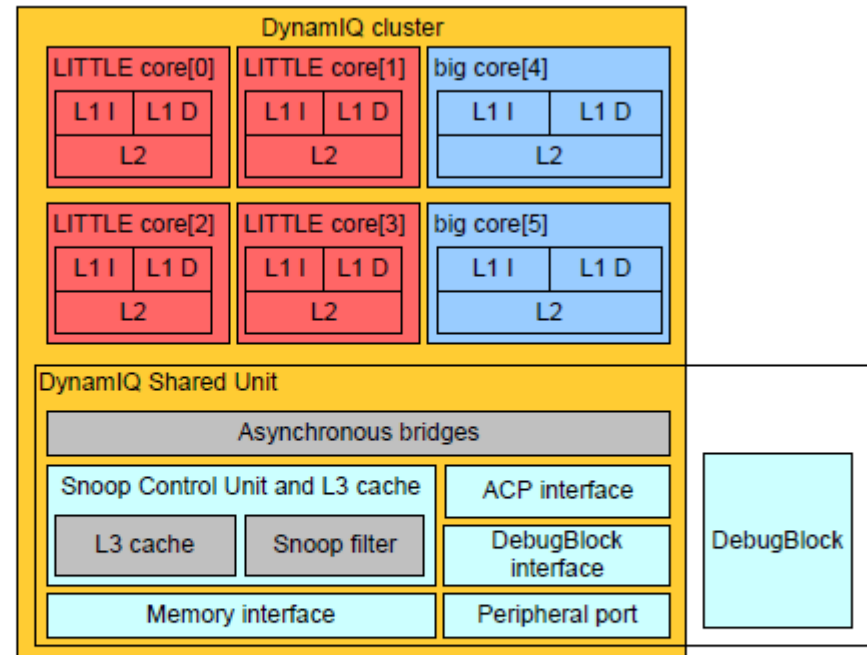


Figure A1-1 DynamIQ cluster

ARM® Cortex®-A55 Core, Revision r1p0, Technical Reference Manual, p. A1-26  
 Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, p. A1-20

a plurality of cache memory blocks;

A plurality of cache memory blocks exists in the L3 cache shared by all ARM cores in a DynamIQ cluster and partitioned into groups of 4 cache ways (blocks).



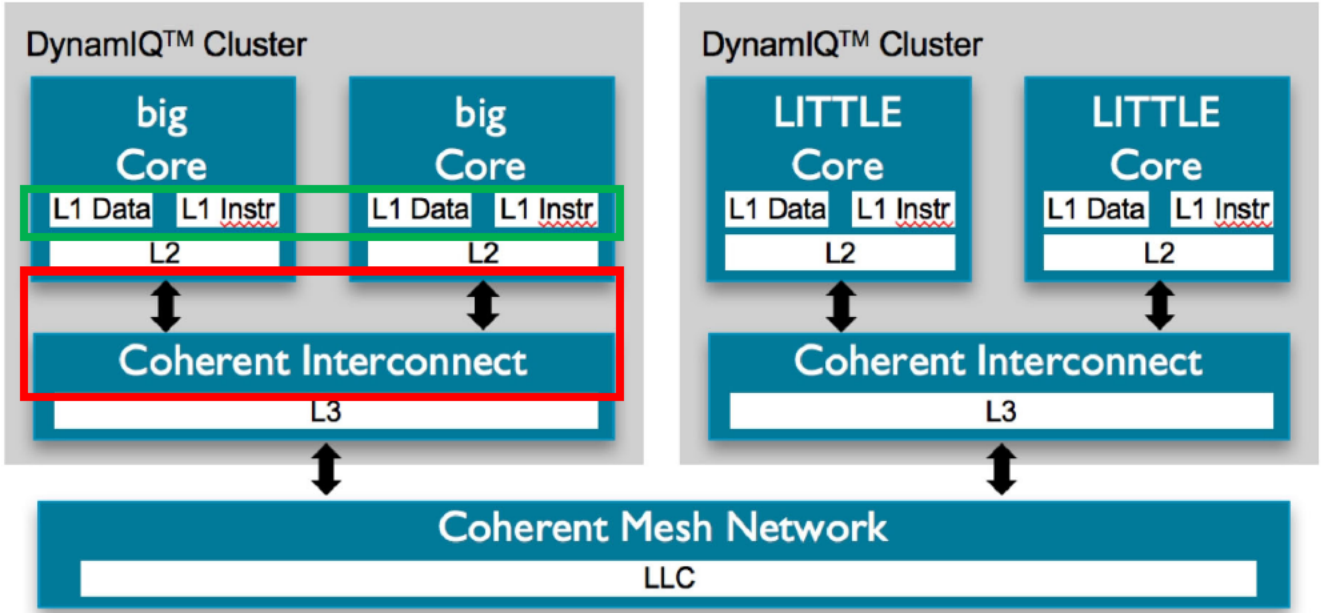
**Figure A1-1 DynamIQ cluster**

Within the DSU, the L3 cache, the *Snoop Control Unit* (SCU), internal interfaces to the cores, and external interfaces to the SoC are present.

Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, p. A1-20

	<p><b>About the L3 cache</b></p> <p>The optional L3 cache is shared by all the cores in the cluster.</p> <p>The L3 cache supports a dynamically optimized allocation policy. Groups of cache ways can be partitioned and assigned to individual processes, allowing cache allocation to be fairly shared between processes.</p> <p>Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, p. A5-64</p>
<p>a high-speed interconnect coupling the plurality of cache memory blocks to the first and second cache controllers such that at least one allocable cache memory block is capable of being used by the first and second cache controllers; and</p>	<p>A high-speed interconnect (e.g., Coherent Interconnect) couples the cache memory blocks of shared L3 cache to the first and second cache controllers (e.g., of the L1D and L1I caches of the first and second cores).</p> <p><b>L3 cache allocation policy</b></p> <p>The L3 cache data allocation policy changes depending on the pattern of data usage.</p> <p>Exclusive allocation is used when data is allocated in only one core. Inclusive allocation is used when data is shared between cores.</p> <p>For example, an initial request from core 0 allocates data in the L1 or L2 caches but is not allocated in the L3 cache. When data is evicted from core 0, the evicted data is allocated in the L3 cache. The allocation policy of this cache line is still exclusive. If core 0 refetches the line, it is allocated in the L1 or L2 caches of core 0 and removed from the L3 cache, keeping the line exclusive. If core 1 then accesses the line for reading, it remains cached in core 0 and is also allocated in both core 1 and L3 caches. In this case, the line has inclusive allocation.</p> <p>Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, p. A5-65</p>



	 <p><a href="https://community.arm.com/developer/ip-products/system/b/soc-design-blog/posts/using-portable-stimulus-in-the-arm-world-creating-bare-metal-sw-coherency-scenarios">https://community.arm.com/developer/ip-products/system/b/soc-design-blog/posts/using-portable-stimulus-in-the-arm-world-creating-bare-metal-sw-coherency-scenarios</a></p>
<p>a resource allocation controller coupled to determine an accessing cache memory controller selected from the group consisting of the first and second cache memory controllers, whereby the accessing cache memory controller is allowed to</p>	<p>A resource allocation controller (e.g., part of the Snoop Control Unit and L3 cache) is coupled (e.g., to the CLUSTERPARTCR register) to determine an accessing cache memory controller selected from the first and second cache controllers, whereby the accessing cache memory controller is allowed to access the allocable cache memory block (in shared L3 cache).</p>

access the allocable cache memory block,

wherein the cache memory blocks are usable by the cache controllers to store data and instructions fetched from a random-access memory.

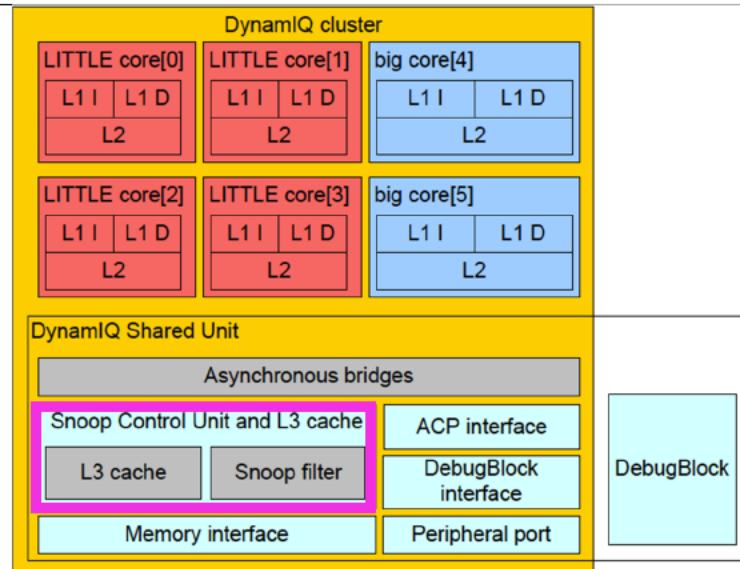


Figure A1-1 DynamIQ cluster

### About the L3 cache

The optional L3 cache is shared by all the cores in the cluster.

The L3 cache supports a dynamically optimized allocation policy. Groups of cache ways can be partitioned and assigned to individual processes, allowing cache allocation to be fairly shared between processes.

### **L3 cache partitioning**

The L3 cache supports a partitioning scheme that alters the victim selection policy to avoid one core (or one group of cores) from utilizing the entire cache at the expense of another core.

Cache partitioning is intended for specialized software where there are distinct classes of processes running with different cache accesses patterns.

For example, two processes (A and B) run on separate cores in the same cluster and therefore share the L3 cache. If process A is more data-intensive than process B, process A might cause all cache lines allocated by process B to be evicted. In this case, the performance of process B might be reduced.

In use, each core in the cluster must be assigned to one of the eight partition scheme IDs. The partitioning is done in groups of cache ways. Each group contains four cache ways. A group can be assigned as private to one or more scheme IDs, or it can be left unassigned. An unassigned group can be shared between all scheme IDs. Accesses from a given core can allocate into any cache way that is assigned as private to that core's partition scheme ID, or to any cache way that is shared.

Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, pp. A1-20, A5-64, A5-66

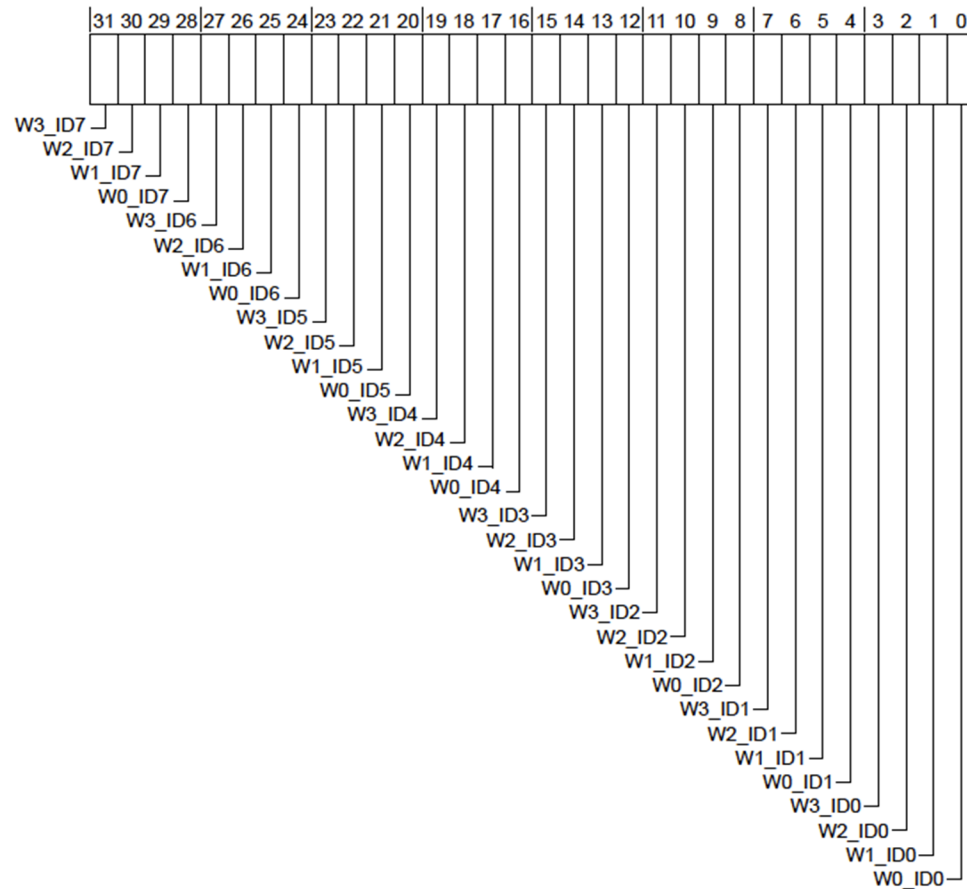
**CLUSTERPARTCR, Cluster Partition Control Register**

The CLUSTERPARTCR register controls a group of ways to be marked as private to a scheme ID. This register is RW.

This description applies to both the AArch32 (CLUSTERPARTCR) and AArch64 (CLUSTERPARTCR\_EL1) registers.

**Bit field descriptions**

CLUSTERPARTCR is a 32-bit register, and is part of SCU and L3 cache configuration registers.



**Figure B1-8 CLUSTERPARTCR bit assignments**

Each bit, if set, indicates that a group of four ways is allocated as private to that scheme ID. If more than one scheme ID assigns the same group of ways as private, then those ways are shared between the scheme IDs that have assigned them as private. All ways not assigned to any scheme ID are treated as shared between all scheme IDs. If a scheme ID does not have any private ways allocated, and there are no remaining shared ways, then any use of the scheme ID will allocate to way group 0, as this is considered a programming error.

Arm® DynamIQ™ Shared Unit, Revision r3p0, Technical Reference Manual, p. B1-132

The Lenovo moto edge 5G comes with 6 GB of RAM

	<div><div><b>Performance</b></div><div><div>Bluetooth</div><div>Bluetooth® 5.2</div></div><div><div>Processor</div><div>Qualcomm® Snapdragon™ 778G mobile platform   Adreno™ 642L GPU</div></div><div><div>Storage</div><div>6GB RAM   128GB or 256GB Storage</div></div><div><div>Operating System</div><div>Android™ 11</div></div><div><div>Hotspot</div><div>Wi-fi hotspot</div></div><div><div>Security</div><div>Side-mounted fingerprint reader   Face unlock   ThinkShield for mobile</div></div></div>
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